

NCE P-Channel Enhancement Mode Power MOSFET

Description

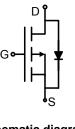
The NCE2333Y uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

General Features

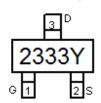
- $V_{DS} = -12V, I_D = -6A$ $R_{DS(ON)} < 45m\Omega(max) @ V_{GS} = -2.5V$ $R_{DS(ON)} < 30m\Omega(max) @ V_{GS} = -4.5V$
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM applications
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



SOT-23-3L top view

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2333Y	NCE2333Y	SOT-23-3L	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-12	V
Gate-Source Voltage	Vgs	±12	V
Drain Current -Continuous	Ι _D	-6	А
Drain Current -Pulsed (Note 1)	I _{DM}	-20	А
Maximum Power Dissipation	PD	1.8	W
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{θJA}	69	°C/W
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-12	-	-	V



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Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-12V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-0.4	-0.65	-1.0	V
Drain Courses On State Desistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-6A	-	19	30	
Drain-Source On-State Resistance		V _{GS} =-2.5V, I _D =-5A	-	26	45	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-6A		17	-	S
Dynamic Characteristics (Note4)						•
Input Capacitance	C _{lss}		-	1100	-	PF
Output Capacitance	C _{oss}	- V _{DS} =-6V,V _{GS} =0V, F=1.0MHz	-	390	-	PF
Reverse Transfer Capacitance	C _{rss}		-	300	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	25	-	nS
Turn-on Rise Time	tr	V _{DD} =-6V,I _D =-1A ,	-	45	-	nS
Turn-Off Delay Time	t _{d(off)}	$R_L=6\Omega, V_{GEN}=-4.5V, R_g=6\Omega$	-	72	-	nS
Turn-Off Fall Time	t _f		-	60	-	nS
Total Gate Charge	Qg		-	11.5	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-6V,I _D =-6A,V _{GS} =-4.5V	-	1.5	-	nC
Gate-Drain Charge	Q _{gd}]	-	3.2	-	nC
Drain-Source Diode Characteristics			•	•		•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-1.0A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-6	Α

Notes:

Repetitive Rating: Pulse width limited by maximum junction temperature.
Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

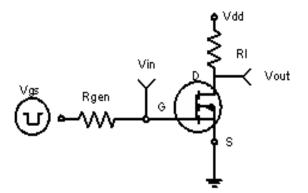
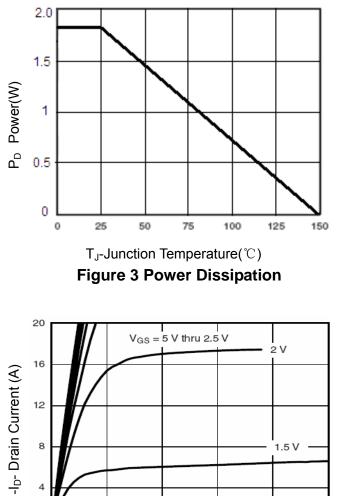


Figure 1:Switching Test Circuit



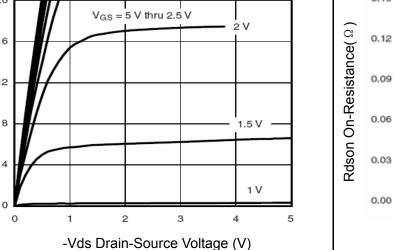


Figure 5 Output Characteristics

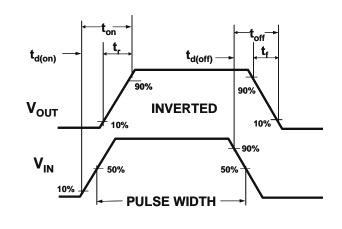
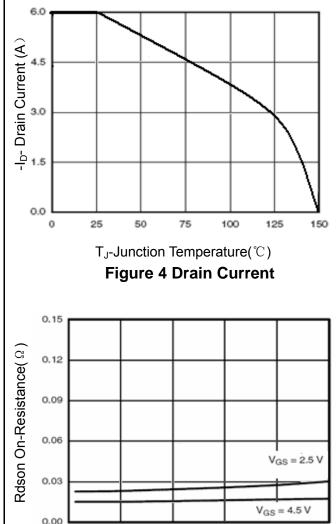


Figure 2:Switching Waveforms





12

8

4

0

8

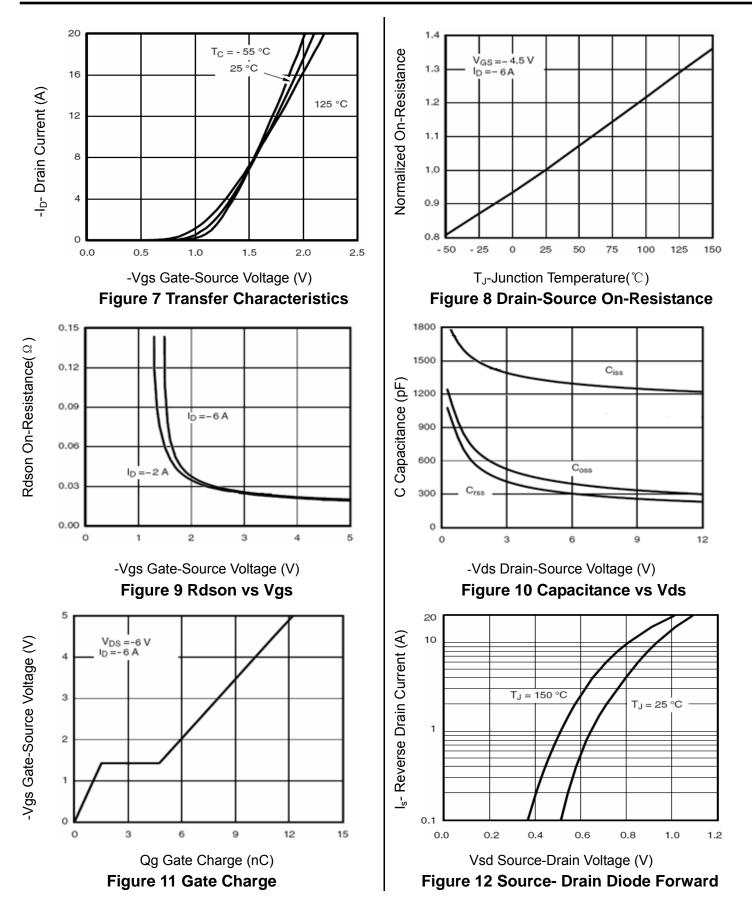
4

16

20

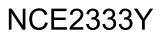


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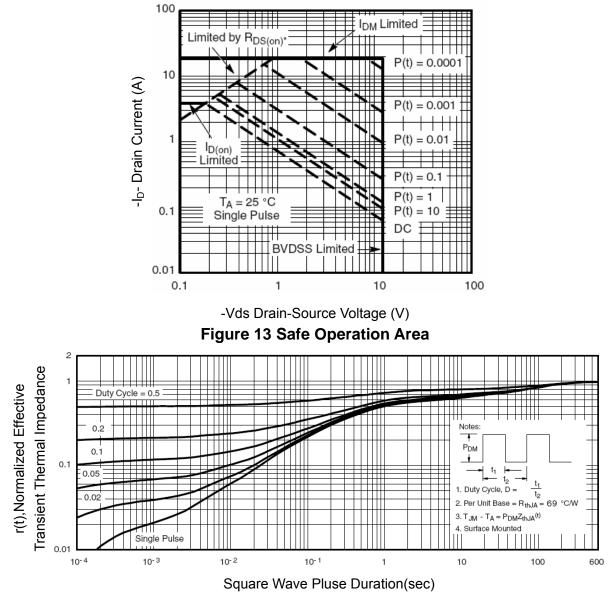
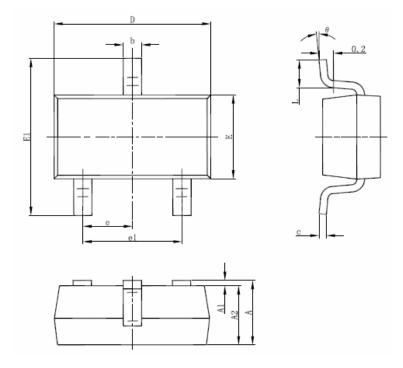


Figure 14 Normalized Maximum Transient Thermal Impedance



SOT-23-3L Package Information



Symbol	Dimensions Ir	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
с	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance $\pm 0.10 \text{mm}$ (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



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